



PDS1040

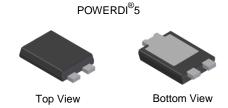
10A SCHOTTKY BARRIER RECTIFIER POWERDI5

Features

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Low Forward Voltage Drop
- Very Low Leakage Current
- High Forward Surge Current Capability
- For use in low voltage, high frequency inverters, freewheeling, and polarity protection applications
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: POWERDI®5
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 @3
- Polarity: See Diagram
- Weight: 0.096 grams (Approximate)





Note: Pins Left & Right must be electrically connected at the printed circuit board.

Ordering Information (Note 4)

| Part Number | Case | Packaging |
|-------------|------------------------|-------------------|
| PDS1040-13 | POWERDI [®] 5 | 5,000/Tape & Reel |
| PDS1040Q-13 | POWFRDI [®] 5 | 5.000/Tape & Reel |

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

POWERDI®5



S1040 = Product Type Marking Code ☐ = Manufacturers' Code Marking YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 15 for 2015) WW = Week Code (01 - 53) K = Factory Designator



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

| Characteristic | Symbol | Value | Unit |
|---|--|-------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | VRRM V _{RWM} V _R | 40 | V |
| RMS Reverse Voltage | V _R (RMS) | 28 | V |
| Average Rectified Output Current | Io | 10 | Α |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load | IFSM | 275 | Α |

Thermal Characteristics

| Characteristic | Symbol | Тур | Max | Unit |
|--|------------------|----------------------------|------|------|
| Thermal Resistance Junction to Soldering Point | $R_{	heta JS}$ | _ | 1.5 | °C/W |
| Thermal Resistance Junction to Ambient Air (Note 5) | $R_{	hetaJA}$ | 95 | _ | °C/W |
| Thermal Resistance Junction to Ambient Air (Note 6) | $R_{	heta JA}$ | 75 | _ | °C/W |
| Thermal Resistance Junction to Ambient Air (Note 7) | $R_{\theta JA}$ | 50 | _ | °C/W |
| Operating Junction Temperature Range $V_R \le 80\% V_{RRM}$ $V_R \le 50\% V_{RRM}$ | TJ | -65 to +150 -65 to +180 | | °C |
| Storage Temperature Range | T _{STG} | -65 to | +150 | °C |

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|------------------------------------|----------------|-----|------|------|------|---|
| Reverse Breakdown Voltage (Note 8) | $V_{(BR)R}$ | 40 | | | V | $I_R = 1mA$ |
| | V _F | _ | 0.45 | 0.49 | V | I _F = 8A, T _S = +25°C |
| Forward Voltage | | _ | 0.47 | 0.51 | | $I_F = 10A, T_S = +25$ °C |
| i olwaru voltage | ٧F | _ | _ | 0.41 | | $I_F = 8A, T_S = +125$ °C |
| | | _ | 0.42 | 0.49 | | $I_F = 10A$, $T_S = +125$ °C |
| | I _R | _ | 0.02 | 0.3 | mΔ | $T_S = +25^{\circ}C, V_R = 35V$ |
| Reverse Leakage Current (Note 8) | | _ | 5.5 | 25 | | $T_S = +100^{\circ}C, V_R = 35V$ |
| Neverse Leakage Guiterii (Note o) | | _ | 0.03 | 0.7 | | $T_S = +25^{\circ}C, V_R = 40V$ |
| | | | 6.5 | 50 | | $T_S = +100^{\circ}C, V_R = 40V$ |

Notes:

- 5. FR-4 PCB, 2oz. Copper, minimum recommended pad layout per http://www.diodes.com.
 6. Polyimide PCB, 2oz. Copper, minimum recommended pad layout per http://www.diodes.com.
 7. Polyimide PCB, 2oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.
 8. Short duration pulse test used to minimize self-heating effect.
 9. Polyimide PCB, 2oz. Copper. Cathode pad dimensions 18.8mm x 14.4mm. Anode pad dimensions 5.6mm x 3.0mm.
- 10. Devices mounted such that $R\theta JA = 19^{\circ}C/W$.



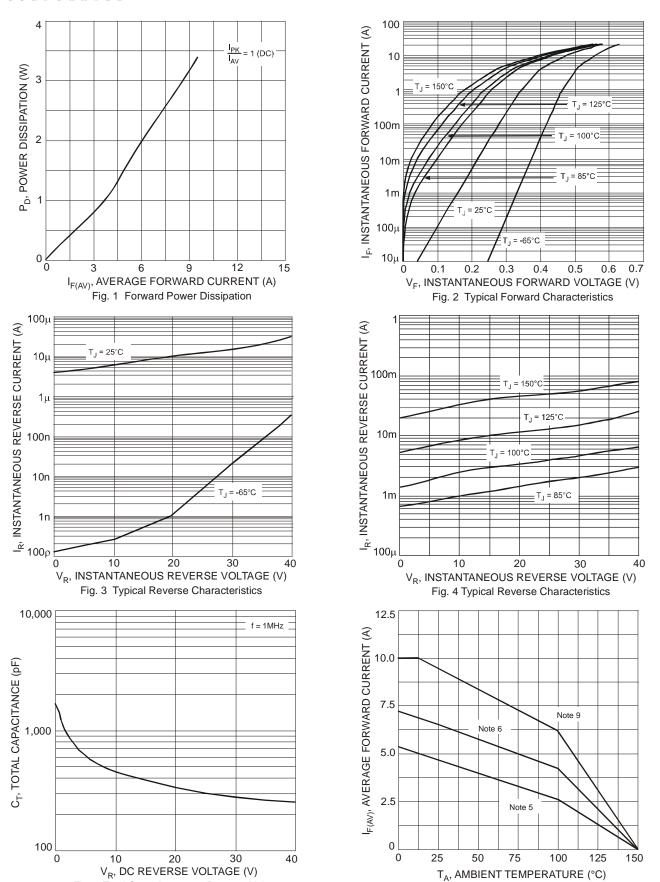
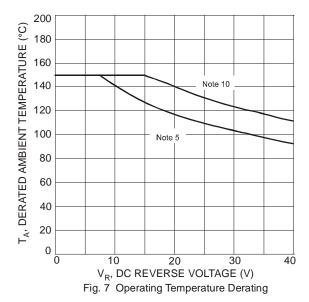


Fig. 5 Total Capacitance vs. Reverse Voltage

Fig. 6 Forward Current Derating Curve

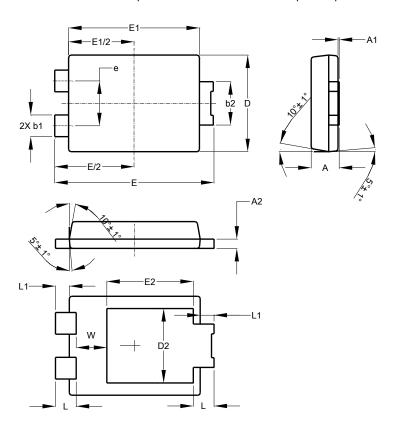






Package Outline Dimensions

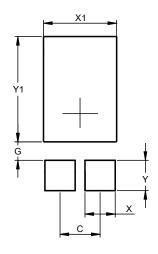
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



| POWERDI [®] 5 | | | | | |
|------------------------|------|------|-------|--|--|
| Dim | Min | Max | Тур | | |
| Α | 1.05 | 1.15 | 1.10 | | |
| A1 | 0.00 | 0.05 | | | |
| A2 | 0.33 | 0.43 | 0.381 | | |
| b1 | 0.80 | 0.99 | 0.89 | | |
| b2 | 1.70 | 1.88 | 1.78 | | |
| D | 3.90 | 4.05 | 3.966 | | |
| D2 | | | 3.054 | | |
| Е | 6.40 | 6.60 | 6.504 | | |
| е | | | 1.84 | | |
| E1 | 5.30 | 5.45 | 5.37 | | |
| E2 | | - | 3.549 | | |
| L | 0.75 | 0.95 | 0.85 | | |
| L1 | 0.50 | 0.65 | 0.57 | | |
| W | 1.10 | 1.41 | 1.255 | | |
| All Dimensions in mm | | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| С | 1.840 |
| G | 0.852 |
| Х | 1.390 |
| X1 | 3.360 |
| Υ | 1.400 |
| Y1 | 4.860 |



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